

Layer	Name	Material	Thickness	Constant	Board Layer	Blank
1	Top Overlay					
	Top Solder	Solder Resist	0.5mil	3.9		
	Top Layer		2.5mil			
2	Dielectric 1	FR4 370	11.5mil	4.2		
	Signal Layer 1		2.5mil			
	Dielectric 2	FR4 370	30.5mil			
3	Signal Layer 2		1.5mil			
	Dielectric 3	FR4 370	11.5mil	4.2		
			2.5mil			
4	Bottom Solder	Solder Resist	0.5mil	3.9		
	Bottom Layer					
	Bottom Overlay					



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